

L Number	Hits	Search Text	DB	Time stamp
1	714	((438/233) or (438/906)).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/02/25 15:23
2	122	((438/233) or (438/906)).CCLS.) and (cmp or (chemical\$3 adj mechanical\$3 adj polish\$3))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/02/25 15:24
3	78	((438/233) or (438/906)).CCLS.) and (cmp or (chemical\$3 adj mechanical\$3 adj polish\$3)) and ((insulat\$4 or dielectric) same (cmp or (chemical\$3 adj mechanical\$3 adj polish\$3)))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/02/25 15:25
4	6	((438/233) or (438/906)).CCLS.) and (cmp or (chemical\$3 adj mechanical\$3 adj polish\$3)) and ((insulat\$4 or dielectric) same (cmp or (chemical\$3 adj mechanical\$3 adj polish\$3))) and ((backside or rear) same (substrate or wafer))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/02/25 15:25
-	5437	((438/167) or (438/197) or (438/199) or (438/402) or (438/457) or (438/458) or (438/459) or (438/476) or (257/632) or (257/633) or (257/634) or (257/635) or (257/639) or (257/640) or (257/641) or (257/642) or (257/643) or (257/644) or (257/645) or (257/649) or (257/650) or (257/651)).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/02/24 21:52
-	715	((438/167) or (438/197) or (438/199) or (438/402) or (438/457) or (438/458) or (438/459) or (438/476) or (257/632) or (257/633) or (257/634) or (257/635) or (257/639) or (257/640) or (257/641) or (257/642) or (257/643) or (257/644) or (257/645) or (257/649) or (257/650) or (257/651)).CCLS.) and (cmp or (chemical\$3 adj mechanical\$3 adj planariz\$6))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/02/24 21:55
-	420	((438/167) or (438/197) or (438/199) or (438/402) or (438/457) or (438/458) or (438/459) or (438/476) or (257/632) or (257/633) or (257/634) or (257/635) or (257/639) or (257/640) or (257/641) or (257/642) or (257/643) or (257/644) or (257/645) or (257/649) or (257/650) or (257/651)).CCLS.) and (cmp or (chemical\$3 adj mechanical\$3 adj planariz\$6))) and ((insulat\$4 or dielectric) same (cmp or (chemical\$3 adj mechanical\$3 adj planariz\$6)))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/02/24 21:56
-	19	((438/167) or (438/197) or (438/199) or (438/402) or (438/457) or (438/458) or (438/459) or (438/476) or (257/632) or (257/633) or (257/634) or (257/635) or (257/639) or (257/640) or (257/641) or (257/642) or (257/643) or (257/644) or (257/645) or (257/649) or (257/650) or (257/651)).CCLS.) and (cmp or (chemical\$3 adj mechanical\$3 adj planariz\$6))) and ((insulat\$4 or dielectric) same (cmp or (chemical\$3 adj mechanical\$3 adj planariz\$6)))) and ((insulat\$4 or dielectric) same (backside or rear) same (substrate or wafer))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/02/25 15:23